## NSN 5962-01-264-5238

Memory Microcircuit - Page 1 of 2



View Online at https://aerobasegroup.com/nsn/5962-01-264-5238 **Body Length:** 0.540 inches **Body Width:** 0.300 inches **Body Height:** 0.092 inches **Maximum Power Dissipation Rating:** 1.0 watts **Operating Tempurature Range:** -55.0/+125.0 degrees celsius Storage Tempurature Range: -65.0/+150.0 degrees celsius **Features Provided:** Hermetically sealed and burn in and monolithic and positive outputs **Inclosure Material:** Ceramic **Inclosure Configuration:** Flat pack **Output Logic Form:** Transistor-transistor logic **Input Circuit Pattern:** 10 input **Case Outline Source And Designator:** F-9 mil-m-38510 **Current Rating Per Characteristic:** 100.00 milliamperes forward current, peak total value not applicable **Terminal Surface Treatment:** Solder Voltage Rating And Type Per Characteristic: -0.5 volts power source and 7.0 volts power source **Time Rating Per Chacteristic:** 25.00 nanoseconds delay **Memory Device Type:** Pal **Test Data Document:** 96906-mil-std-883 standard (includes industry or association standards, individual manufactureer standards, etc.). **Terminal Type And Quantity:** 20 flat leads Shelf Life: N/a

**Unit Of Measure:** 

## NSN 5962-01-264-5238

Memory Microcircuit - Page 2 of 2



Demilitarization:

No

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